

SPV1050

Datasheet - **production data**

Ultralow power energy harvester and battery charger

Features

- Transformerless thermoelectric generators and PV modules energy harvester
- High efficiency for any harvesting source
- Up to 70 mA maximum battery charging current
- Fully integrated buck-boost DC-DC converter
- Programmable MPPT by external resistors
- 2.6 V to 5.3 V trimmable battery charge voltage level (± 1% accuracy)
- 2.2 V to 3.6 V trimmable battery discharge voltage level (± 1% accuracy)
- Two fully independent LDOs (1.8 V and 3.3 V output)
- Enable/disable LDO control pins
- Battery disconnect function for battery protection
- Battery connected and ongoing charge logic open drain indication pins

Applications

- Charge any battery type, including lithium based, solid state thin film and super-capacitor.
- WSN, HVAC, building and home automation, industrial control, remote metering, lighting, security, surveillance.
- Wearable and biomedical sensors, fitness.

Description

The SPV1050 is an ultralow power and highefficiency energy harvester and battery charger, which implements the MPPT function and integrates the switching elements of a buck-boost converter.

The SPV1050 device allows the charge of any battery, including the thin film batteries, by tightly monitoring the end-of-charge and the minimum battery voltage in order to avoid the overdischarge and to preserve the battery life.

The power manager is suitable for both PV cells and TEG harvesting sources, as it covers the input voltage range from 75 mV up to 18 V and guarantees high efficiency in both buck-boost and boost configuration.

Furthermore the SPV1050 device shows very high flexibility thanks also to the trimming capability of the end-of-charge and undervoltage protection voltages. In such way any source and battery is matched.

The MPPT is programmable by a resistor input divider and allows maximizing the source power under any temperature and irradiance condition.

An unregulated voltage output is available (e.g. to supply a microcontroller), while two fully independent LDOs are embedded for powering sensors and RF transceivers. Both LDOs (1.8 V and 3.3 V) can be independently enabled through two dedicated pins.

This is information on a product in full production.

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1. Measured on 2-layer application board FR4, Cu thickness = 17 um with total exposed pad area = 16 mm²

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5 Electrical characteristics

V_{STORE} = 4 V, T_{amb} = - 40 to 85 °C, unless otherwise specified. Voltage with respect to GND unless otherwise specified.

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit		
$I_{LDO2}(1)$	I_{OUT} max from LDO2		$\overline{}$	$\overline{}$	200	mA		
$V_{LDO1,2_EN_H}$	LDO1,2 enable input HIGH	$\overline{}$		$\overline{}$	$\overline{}$	v		
$V_{LDO1,2_EN_L}$	LDO1,2 enable input LOW	$\overline{}$			0.5	v		
Digital output								
V _{BATT_CONN_L}	V _{BATT DIS} LOW	1 mA sink current	40	70	150	mV		
VBATT_CHG_L	V _{XBATT_CHG} LOW	1 mA sink current	40	70	150	mV		

Table 4. Electrical characteristics (continued)

1. Guaranteed by design, not tested in production.

6 Functional description

The SPV1050 is an ultralow power energy harvester with an embedded MPPT algorithm, a battery charger and power manager designed for applications up to about 400 mW.

The SPV1050 device integrates a DC-DC converter stage that can be configured as boost or buck-boost by tying the CONF pin to PV+/TEG+ or to ground respectively as shown in *[Figure 4](#page-15-1)* and *[Figure 12 on page 20](#page-19-1)*.

If the embedded MPPT algorithm is enabled, the device regulates the working point of the DC-DC converter in order to maximize the power extracted from the source by tracking its output voltage. See further details in *[Section 6.2: Boost configuration on page 16](#page-15-0)* and *[Section 6.3: Buck-boost configuration on page 20](#page-19-0)*.

The MPPT algorithm can be disabled by shorting the MPP-SET pin to the STORE pin, and by providing an external voltage to the MPP-REF pin.

In case of low impedance source (e.g. USB), the MPP-REF must be connected to GND. The IC will switch at the highest duty cycle possible until the V_{FOC} on the STORE pin is triggered.

In case of high impedance source with limited current capability (i.e. if the source is unable to sustain switching at the maximum duty cycle), the MPP-REF pin must be connected to a voltage reference selected such that $V_{MPP-REF} > V_{IN(MIN)}$. This voltage reference can be set through a resistor ladder connected to STORE or any other voltage reference available in the application.

If the MPP pin is connected to the source by a resistor ladder, then the same consideration must be extended to the MPP pin. Referring to *[Figure 19](#page-23-1)* (where connections between MPP-SET to R2-R3 must be open and MPP-SET must be considered as connected to STORE):

- $-$ If R1 = 0 Ω: then V_{MPP-REF} = V_{IN(MIN)}
- Otherwise: $V_{\text{MPP-REF}} = V_{\text{MPP(MIN)}} = V_{\text{IN(MIN)}}$ * (R2+R3)/R1

6.1 Battery charger

In order to guarantee the lifetime and safety of the battery, the SPV1050 device controls an integrated pass transistor between the STORE and BATT pins and implements both the undervoltage (UVP) and the end-of-charge (EOC) protection thresholds.

Figure 3. Battery management section

Before the first startup the pass transistor is open, so that the leakage from the battery is lower than 1 nA. The pass transistor will be closed once the voltage on the STORE pin will rise such that the EOC threshold V_{EOC} is triggered. If the battery is full, and until V_{STORE} > V_{EOC} - EOC_{HYS}, the DC-DC converter will stop switching to avoid battery overcharge.

On the contrary, in order to avoid the overdischarge of the battery, the pass transistor will be opened once the voltage on the STORE pin will decrease down to UVP threshold V_{I_1} _{NP}.

These functions are simply implemented by the control of two voltage thresholds, V_{UVP} and V_{EOC} , which can be regulated by a resistor partitioning (R4, R5, R6) between STORE, UVP and EOC pins.

The scaled voltages on the UVP and EOC pins will be compared with the internal bandgap voltage reference V_{BG} set at 1.23 V.

The design rules to setup the R4, R5 and R6 are the following:

Equation 1

 $V_{BG} = V_{UVP}$ \cdot (R5 + R6) / (R4 + R5 + R6)

Equation 2

 $V_{BG} = V_{EOC} \cdot R6 / (R4 + R5 + R6)$

In order to minimize the leakage due to the output resistor partitioning it has to be typically:

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Equation 3

$$
10~M\Omega \leq R4+R5+R6 \leq 20~M\Omega
$$

Further, the SPV1050 device provides two open drain digital outputs to an external microcontroller:

• BATT_CONN

This pin is pulled down when the pass transistor is closed. It will be released once the pass transistor will be opened (e.g. triggering of V_{UVP}). If used, this pin must be pulledup to the STORE by a 10 M Ω (typical) resistor.

BATT_CHG

This pin is pulled down when the DC-DC converter is switching, while it's released when it is not switching, i.e. when the EOC threshold is triggered until the voltage on the STORE pin drops at V_{EOC} - EOC_{HYS}, when the UVLO threshold is triggered or during the T_{SAMPLE} of the MPPT algorithm. If used, this pin must be pulled-up to the STORE by a 10 $\overline{M\Omega}$ (typical) resistor.

6.2 Boost configuration

[Figure 4](#page-15-1) shows the boost application circuit.

Figure 4. Boost configuration

In case of boost configuration, once the harvested source is connected, the SPV1050 device will start boosting the voltage on the STORE pin. In the range of 0 \leq V_{STORE} < 2.6 V the voltage boost is carried on by an integrated high-efficiency charge pump, while the DC-DC converter stage will remain OFF.

[Figure 5](#page-16-0) shows the behavior of input voltage V_{IN} and V_{STORF} at the startup.

Figure 5. Boost startup

In the range 2.6 V \leq V_{STORE} \leq V_{EOC} the voltage is boosted by the DC-DC converter. In this voltage range the SPV1050 device sets its internal impedance according to the integrated MPPT algorithm (the MPPT mode is active). The SPV1050 device will stop switching for 400 ms (T_{SAMPLE}) every 16 seconds ($T_{TRACKING}$). During the T_{SAMPLE} , the input open circuit voltage V_{OC} is sampled by charging the capacitor on the MPP-REF pin. Once the T_{SAMPL} is elapsed, the DC-DC converter will start switching back by setting its own impedance such that V_{IN} stays as close as possible to V_{MPP} of the source. A resistor partitioning connected between the source and the pins MPP and MPP-SET has to be properly selected, in order to match the manufacturer's specs. Please refer to *[Section 6.4:](#page-23-0) [MPPT setting on page 24](#page-23-0)* for further details.

The periodic sampling of V_{OC} guarantees the best MPPT in case of source condition variations (e.g. irradiation/thermal gradient and/or temperature changes).

[Figure 6](#page-17-0) shows the input voltage waveform of a PV panel supplying V_{OC} = 1.25 V and V_{MPP} = 1.05 V.

Figure 6. MPPT tracking

Once the $\rm V_{EOC}$ threshold is triggered, the switching of the DC-DC converter is stopped until $\rm{V_{STORE}}$ will decrease to $\rm{V_{EOC}}$ - $\rm{EOC_{HYS}}.$

Figure 7. Triggering of V_{EOC} (BATT pin floating)

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The following plots from *[Figure 8](#page-18-0)* to *[Figure 11](#page-18-3)* show the power efficiency of the DC-DC converter configured in boost mode at T_{amb} = 25 °C in some typical use cases at different open circuit voltages:

6.3 Buck-boost configuration

[Figure 12](#page-19-1) shows the buck-boost application circuit.

Figure 12. Buck-boost configuration

In case of buck-boost configuration, once the harvested source is connected, the IN_HV and STORE pins will be internally shorted until V_{STORF} < 2.6 V. *[Figure 13](#page-20-0)* shows the behavior of the input voltage V_{IN-HV} and V_{STORE} at the startup.

Figure 13. Buck-boost startup ($I_{IN} = 5 \mu A$ **)**

In the range 2.6 V \leq V_{STORE} \leq V_{EOC} the integrated DC-DC converter will start switching. In this operating range the SPV1050 input impedance is set by the embedded MPPT algorithm (the MPPT mode is active). The SPV1050 device will stop switching for 400ms (T_{SAMPLE}) every 16 seconds (T_{TRACKING}). During the T_{SAMPLE}, the input open circuit voltage V_{OC} is sampled by charging the capacitor on the MPP-REF pin. Once the T_{SAMPLE} is elapsed, the DC-DC converter will start switching back by setting its own impedance such that V_{IN} stays as close as possible to V_{MPP} of the source. A resistor partitioning connected between the source and the pins MPP and MPP-SET has to be properly selected in order to match the V_{MPP} given by the source manufacturer. Please refer to *[Section 6.4: MPPT setting](#page-23-0)* for further details.

The periodic sampling of V_{OC} guarantees the best MPPT in case of source condition variations (e.g. irradiation and/or temperature changes).

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 $_{0.6}$

 0.01 0.1 1 10 100

Input current [mA]

The following plots from *[Figure 15](#page-22-0)* to *[Figure 18](#page-22-3)* show the power efficiency of the DC-DC converter configured in buck-boost mode at T_{amb} = 25 °C in some typical use cases:

 $_{0.6}$

 0.01 0.1 1 10 100

Input current [mA]

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6.4 MPPT setting

When the MPPT feature is enabled, the SPV1050 device sets its working point such that V_{IN} = V_{MPP} . In fact, V_{MPP} is a fraction of the open circuit voltage V_{OC} of the harvesting source.

The maximum power point is set through the input resistor partitioning R1, R2 and R3.

First of all, set the total input resistance $(R1 + R2 + R3)$ considering the maximum acceptable leakage current (I_{LEAKAGE}):

Equation 4

$$
I_{LEAKAGE} = V_{OC} / (R1 + R2 + R3)
$$

Typically, assuming 10 M Ω ≤ R1 + R2 + R3 ≤ 20 M Ω , the leakage on the input resistor partitioning can be considered as negligible.

Then set the R2 + R3 selecting the minimum between the results of equations *[5](#page-23-2)* and *[6](#page-23-3)* which consider that the voltage on the MPP pin must be lower than the minimum $V_{\text{UVP}}(V_{\text{UVP}(min)})$ = 2.2 V) and the energy balance on the inductor even at very low input power (see details in Appendix A, Application tips), respectively:

Equation 5

R2 + R3 ≤ (R1 + R2 + R3) * VUVP(min) / VOC

Equation 6

 $R2 + R3 \le 51 * (R1 + R2 + R3) * V_{MPP(min)} / V_{EOC}$

Finally, set the R3 considering the MPP_{RATIO} (in case of PV panels MPP_{RATIO} = V_{MP} / V_{OC}):

Equation 7

$$
MPPRATIO = R3 / (R2 + R3)
$$

In boost mode if the electrical characteristics of the selected source and battery are such that $V_{OC\text{-MAX}} \leq V_{U\setminus P(\text{min})}$, then the resistor R1 can be replaced by a short-circuit. Consequently, only R2 and R3 have to be selected for a proper setting of MPP $_{\text{RATIONAL}}$.

In a PV panel the V_{MPP} is typically within 70% \div 80% of V_{OC}.

In a TEG the V_{MPP} is typically about 50% of V_{OC}.

The MPPT accuracy can be strongly affected by an improper selection of the input capacitor. The input capacitance C_{IN} = 4.7 μ F generally covers the most typical use cases.

The energy extracted from the harvested source, and stored in the input capacitance, is transferred to the load by the DC-DC converter through the inductor. The energy extracted by the inductor depends by the sink current: the higher input currents cause higher voltage drop on the input capacitance and this may result a problem for low voltage $(< 1 V)$ and high energy (> 20 mA) sources. In such application cases the input capacitance has to be increased or, alternatively the L1 inductance has to be reduced.

During the T_{SAMPLE} time frame the input capacitor C_{IN} is charged up to V_{OC} by the source with a T1 time constant resulting from the capacitance and the equivalent resistance R_{EQ} of the source.

In case of the PV source, assuming I_{MPP} the minimum current at which the MPP must be guaranteed, the REQ can be calculated as following:

Equation 8

$$
R_{EQ} = (V_{OC} - V_{MPP}) / I_{MPP} = V_{OC} \cdot (1 - MPP_{RATIO}) / I_{MPP}
$$

Thus C_{IN} is calculated by the following formula:

Equation 9

$$
C_{IN} \leq T1 / R_{EQ}
$$

The following plots in *[Figure 20](#page-25-1)* and *[Figure 21](#page-25-2)* show the effect of different C_{IN} values on the time constant. If the capacitance is too high, the capacitor may not be charged within the T_{SAMPI} = 400 ms time window, thus affecting the MPPT accuracy.

6.5 Power manager

The SPV1050 device works as a power manager also by providing one unregulated output voltage on the STORE pin and two regulated voltages on the LDO1 (1.8 V) and LDO2 (3.3 V) pins.

Each LDO can be selectively enabled or disabled by driving the related enable/disable pins LDO1_EN and LDO2_EN.

The performances of the LDOs can be optimized by selecting a proper capacitor between the LDO output pin and ground. A 100 nF for each LDO pin is suitable for the most typical use cases. *[Figure 22](#page-26-0)* and *[Figure 23](#page-26-1)* show the behavior of the LDOs when a 100 mA load is connected.

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7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.

7.1 VFQFPN20 3 x 3 x 1 mm - 20-lead pitch 0.4 package information

Figure 24. VFQFPN20 3 x 3 x 1 mm - 20-lead pitch 0.4 package outline

1. The pin #1 identifier must exist on the top surface of the package by using an indentation mark or an other feature of the package body. Exact shape and size of this feature is optional.

	10010 01 11 C1 1 1120 0 A 0 A 1 111111 20 1000 phon 0.4 public go involution and			
Symbol		Note		
	Min.	Typ.	Max.	
A	0.80	0.90	1.00	
A1	\overline{a}	0.02	0.05	
A2		0.65	1.00	
A ₃		0.20		
b	0.15	0.20	0.25	
D	2.85	3.00	3.15	
D ₁		1.60		(1)
D ₂	1.50	1.60	1.70	
E.	2.85	3.00	3.15	
E1		1.60		
E ₂	1.50	1.60	1.70	
e	0.35	0.40	0.45	
L	0.30	0.40	0.50	
ddd			0.07	

Table 5. VFQFPN20 3 x 3 x 1 mm - 20-lead pitch 0.4 package mechanical data

1. "VFQFPN" stands for "Thermally Enhanced Very thin Fine pitch Quad Packages No lead".
Very thin: 0.80 < A ≤ 1.00 mm / fine pitch: e < 1.00 mm.

Figure 25. Die form pad position (top view)

apio oi Dio pau oooramatoo anu pau oiLo								
Pad name	X position $[\mu m]$	Y position[μ m]	Pad dimension [µm]					
IN_HV	-416.55	594.09						
L HV	-264.75	594.09						
SUB	-126.87	594.09						
PGND	10.99	594.09						
IN LV	142.65	594.09						
PSTORE	373.43	594.09						
STORE	594.09	455.22						
BATT	594.09	303.42						
CONF	594.09	-6.9						
LDO ₂	594.09	-152.33						
LDO1	594.09	-310.59	81.05 x 81.05					
UVP	439.39	-594.09						
EOC	281.45	-594.09						
BATT OK	135.88	-594.09						
BATT CHG	-18.03	-594.09						
LDO _{2_EN}	-377.15	-594.09						
LDO1_EN	-594.09	-430.77						
GND	-594.09	-278.97						
MPP REF	-594.09	-135.06						
MPP_SET	-594.09	148.12						
MPP	-594.09	299.92						

Table 6. Die pad coordinates and pad size

8 Ordering information

Appendix A Application tips

In DC-DC converters the energy is transferred from the input to the output through the inductor. During the ON phase of the duty cycle, the inductor stores energy while during the OFF phase of the duty cycle, the energy is released toward the output stage.

The SPV1050 controls the duty cycle of the driving signal by comparing the voltages on the MPP and MPP-REF pins. When V_{MPP} rises higher than $V_{MPP-RFF}$, the IC switches ON and the inductor is loaded for T_{ON} until one of the following events occurs:

- V_{STORF} triggers the EOC threshold
- The inductor current (I_L) triggers the internal threshold I_{L(PEAK)} (= 140 mA, typ.)
- $T_{ON(MAX)} = 10$ µs elapses

The energy stored in the inductor will be released to the output stage during the OFF phase. During T_{OFF}, I_L decreases to 0 mA (all energy has been released). According to the internal controls of the IC, $\sf{T}_{\mathsf{OFF(MIN)}}$ = 0.2 µs then, in order to prevent I_L becoming negative, the application must be designed such that the energy stored in the inductor during T_{ON} is always greater or equal to the energy released during T_{OFF} . This goal can be achieved through the proper selection of R2 + R3. Thus, in order to guarantee $I_{L(MIN)}$ > 0, it must be:

Equation 10

$$
I_{L(MIN)} = I_H - \frac{V_{STORE} - V_{IN}}{L} \times T_{OFF(MIN)} > 0
$$

Equation 11

$$
I_{L(MIN)} = \frac{V_{IN}}{L} \times T_{ON(MAX)} - \frac{V_{STORE} - V_{IN}}{L} \times T_{OFF(MIN)} > 0
$$

Which leads to:

Equation 12

$$
V_{IN} > V_{STORE} \times \frac{T_{OFF(MIN)}}{T_{ON(MAX)} + T_{OFF(MIN)}}
$$

Finally, considering the worst case $V_{\text{STORE}} = V_{\text{EOC}}$, the minimum operating voltage $V_{\text{MPP}} =$ $\mathsf{V}_{\mathsf{MPP}(\mathsf{MIN})}$ and the resistor partitioning between V_{IN} and $\mathsf{V}_{\mathsf{MPP}}$:

Equation 13

$$
(R_2 + R_3) = (R_1 + R_2 + R_3) \times \frac{V_{MPP(MIN)}}{V_{EOC}} \times \frac{T_{ON} + T_{OFF}}{T_{OFF}}
$$

9 Revision history

Table 8. Document revision history

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